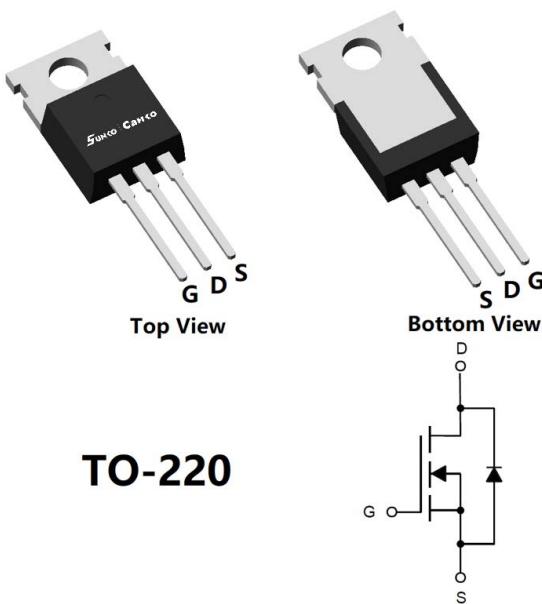


N-Channel Enhancement Mode Field Effect Transistor



Product Summary

- V_{DS} 100V
- I_D 180A
- $R_{DS(ON)}$ (at $V_{GS}=10V$) $<3.3m\Omega$
- 100% EAS Tested
- 100% ∇V_{DS} Tested

General Description

- Split gate trench MOSFET technology
- Excellent package for heat dissipation
- High density cell design for low $R_{DS(ON)}$
- Epoxy Meets UL 94 V-0 Flammability Rating
- Halogen Free

Applications

- Power switching application
- Uninterruptible power supply
- DC-DC convertor

Absolute Maximum Ratings ($T_A=25^\circ C$ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-source Voltage	V_{DS}	100	V
Gate-source Voltage	V_{GS}	± 20	V
Drain Current	I_D	24	A
		15	
		180	
		113	
Pulsed Drain Current ^A	I_{DM}	720	A
Avalanche energy ^B	EAS	1156	mJ
Total Power Dissipation ^C	P_D	4	W
		1.5	
		312	
		125	
Junction and Storage Temperature Range	T_J, T_{STG}	-55~+150	°C

Thermal resistance

Parameter	Symbol	Typ	Max	Units
Thermal Resistance Junction-to-Ambient ^D	$R_{\theta JA}$	25	30	°C/W
Thermal Resistance Junction-to-Case	$R_{\theta JC}$	0.35	0.4	

Ordering Information (Example)

PREFERRED P/N	PACKING CODE	Marking	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
SCP180G10H	B1	SCP180G10H	50	/	5000	Tube

■ Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Static Parameter						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$	100	-	-	V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{\text{DS}}=100\text{V}, V_{\text{GS}}=0\text{V}$	-	-	1	μA
		$V_{\text{DS}}=100\text{V}, V_{\text{GS}}=0\text{V}, T_J=150^\circ\text{C}$	-	-	100	
Gate-Body Leakage Current	I_{GSS}	$V_{\text{GS}}=\pm20\text{V}, V_{\text{DS}}=0\text{V}$	-	-	±100	nA
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=250\mu\text{A}$	2	3	4	V
Static Drain-Source On-Resistance	$R_{\text{DS}(\text{ON})}$	$V_{\text{GS}}=10\text{V}, I_{\text{D}}=50\text{A}$	-	2.4	3.3	$\text{m}\Omega$
Diode Forward Voltage	V_{SD}	$I_{\text{S}}=50\text{A}, V_{\text{GS}}=0\text{V}$	-	-	1.2	V
Gate resistance	R_{G}	f=1MHz, Open drain	-	0.4	-	Ω
Maximum Body-Diode Continuous Current	I_{S}		-	-	180	A
Dynamic Parameters						
Input Capacitance	C_{iss}	$V_{\text{DS}}=50\text{V}, V_{\text{GS}}=0\text{V}, f=1\text{MHz}$	-	8900	-	pF
Output Capacitance	C_{oss}		-	2750	-	
Reverse Transfer Capacitance	C_{rss}		-	65	-	
Switching Parameters						
Total Gate Charge	Q_{g}	$V_{\text{GS}}=10\text{V}, V_{\text{DS}}=50\text{V}, I_{\text{D}}=90\text{A}$	-	122	-	nC
Gate-Source Charge	Q_{gs}		-	37	-	
Gate-Drain Charge	Q_{gd}		-	29	-	
Reverse Recovery Charge	Q_{rr}	$I_{\text{F}}=90\text{A}, \text{di}/\text{dt}=400\text{A}/\text{us}$	-	317	-	nC
Reverse Recovery Time	t_{rr}		-	56	-	ns
Turn-on Delay Time	$t_{\text{D(on)}}$	$V_{\text{GS}}=10\text{V}, V_{\text{DD}}=50\text{V}, I_{\text{D}}=90\text{A}$ $R_{\text{GEN}}=2.2\Omega$	-	25	-	ns
Turn-on Rise Time	t_{r}		-	194	-	
Turn-off Delay Time	$t_{\text{D(off)}}$		-	52	-	
Turn-off fall Time	t_{f}		-	13	-	

- A. Repetitive rating; pulse width limited by max. junction temperature.
 B. $T_J=25^\circ\text{C}, V_{\text{DD}}=95\text{V}, V_{\text{G}}=10\text{V}, R_{\text{G}}=25\Omega, L=2\text{mH}, I_{\text{AS}}=34\text{A}$.
 C. P_d is based on max. junction temperature, using junction-case thermal resistance.
 D. The value of R_{GJA} is measured with the device mounted on the minimum recommend pad size, in the still air environment with $T_A=25^\circ\text{C}$. The maximum allowed junction temperature of 150°C . The value in any given application depends on the user's specific board design.

■ Typical Electrical and Thermal Characteristics Diagrams

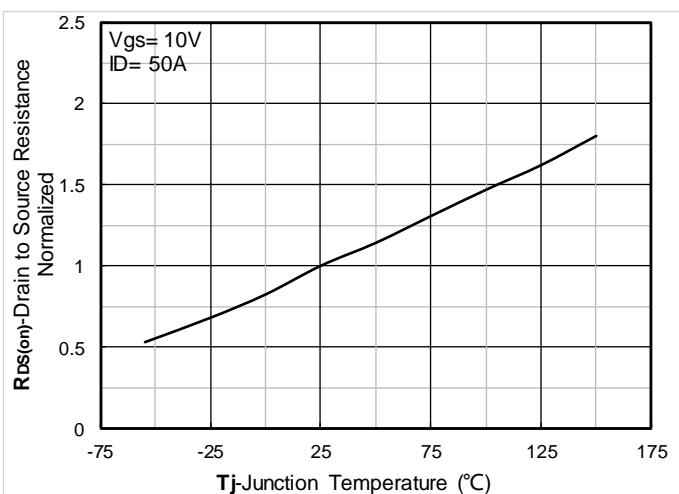
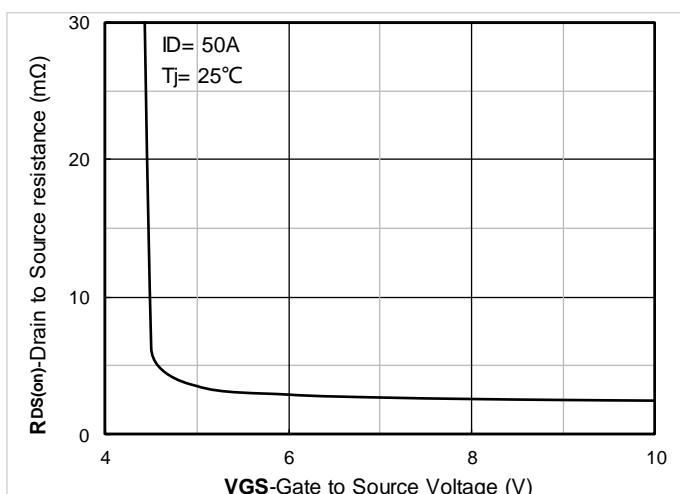
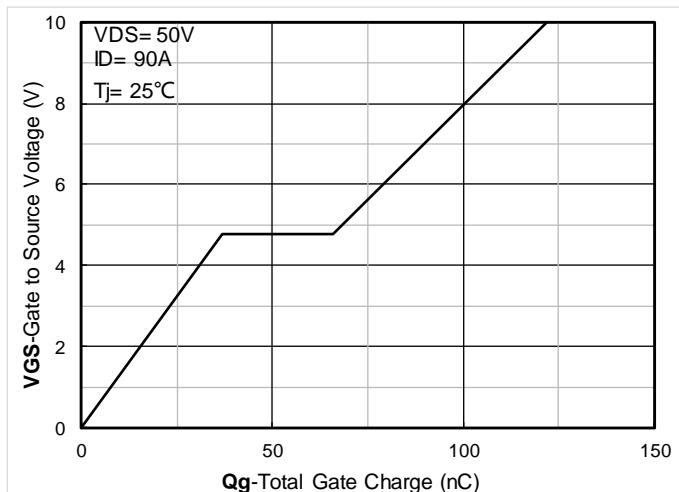
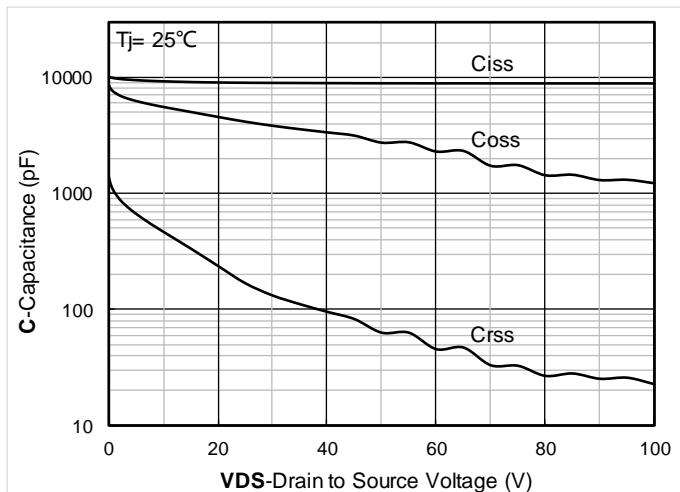
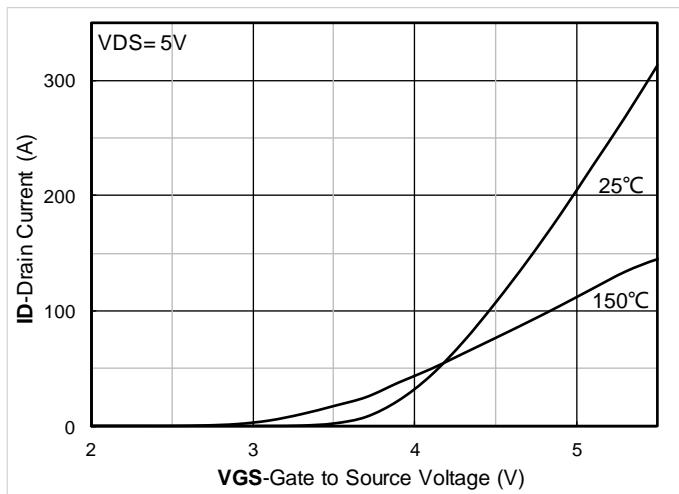
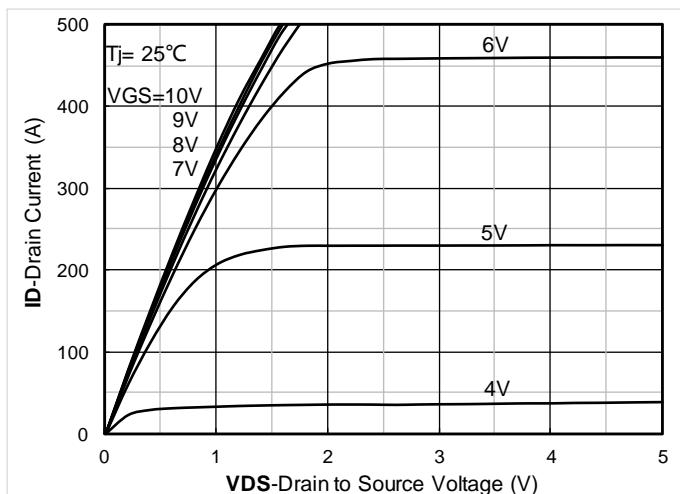


Figure 5. On-Resistance vs Gate to Source Voltage

Figure 6. Normalized On-Resistance

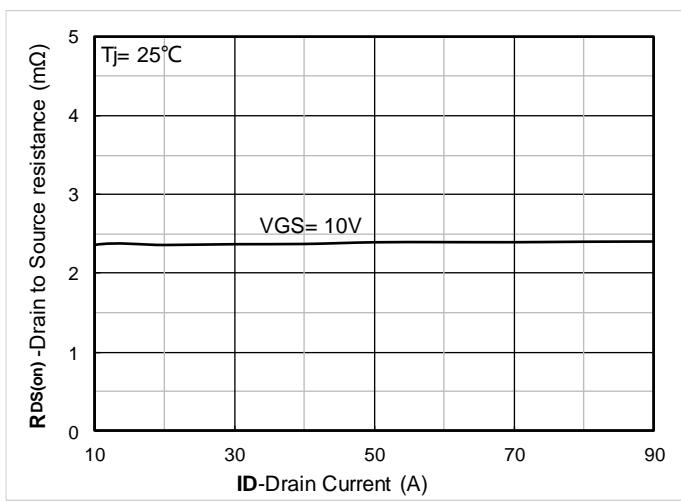
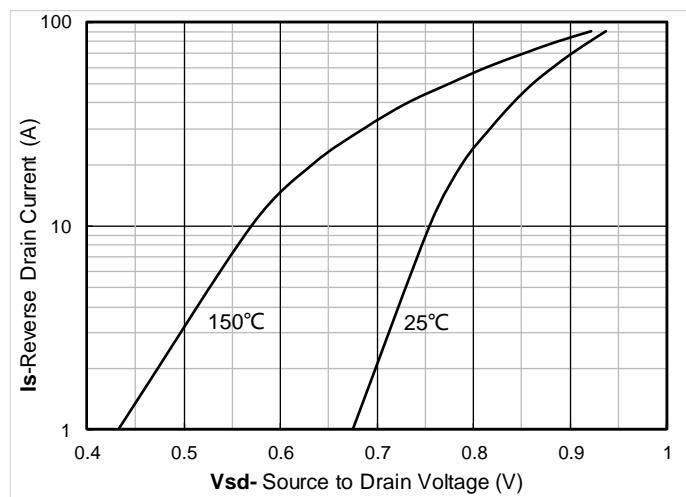
Figure 7. $R_{DS(on)}$ VS Drain Current

Figure 8. Forward characteristics of reverse diode

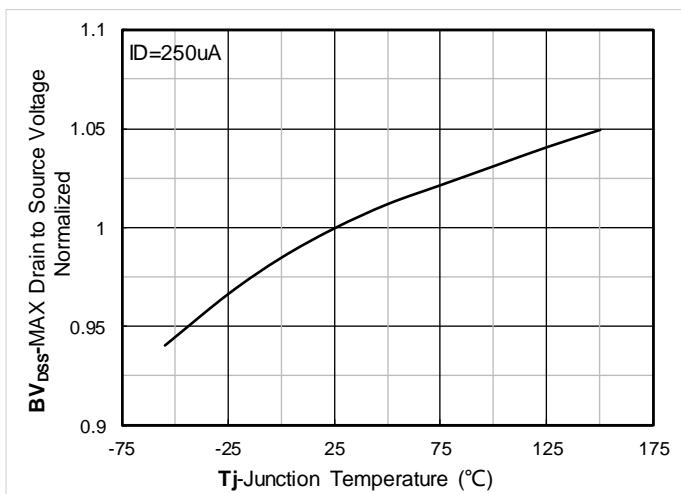


Figure 9. Normalized breakdown voltage

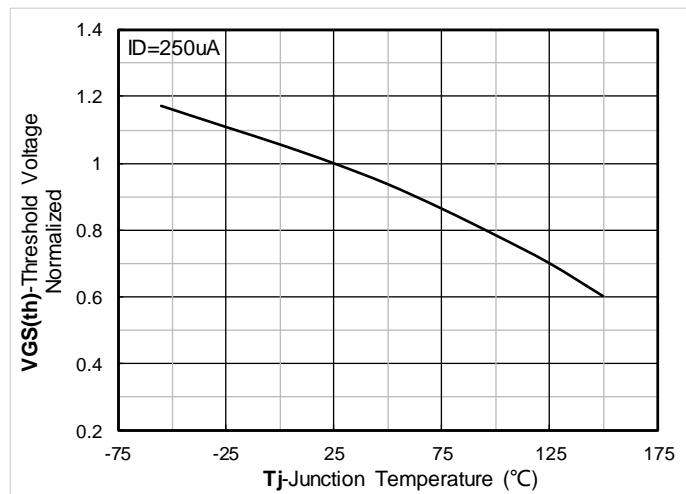


Figure 10. Normalized Threshold voltage

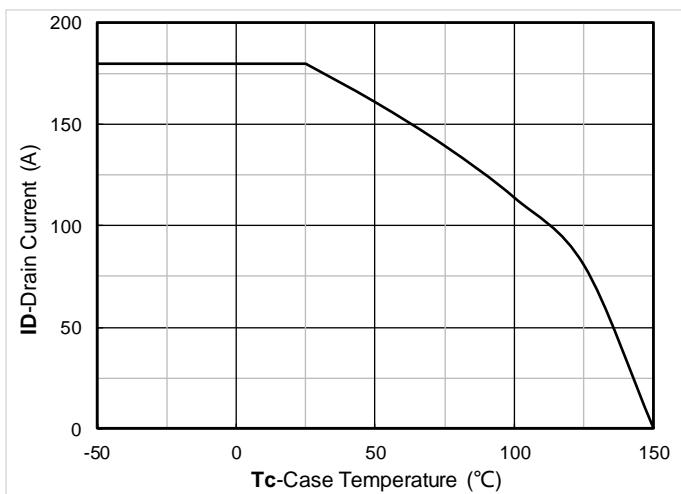


Figure 11. Current dissipation

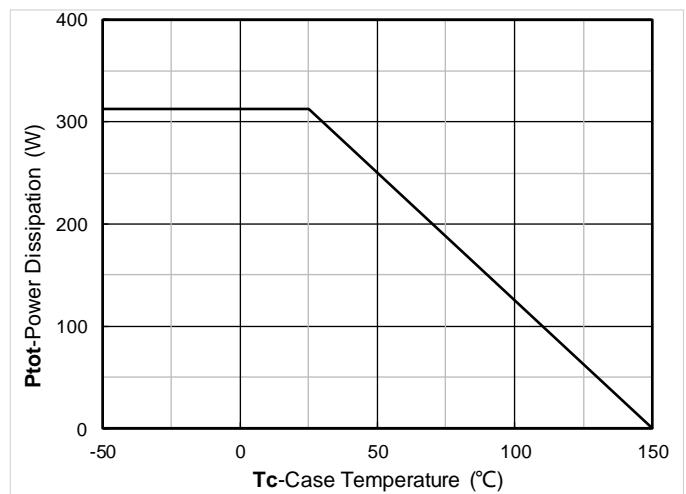


Figure 12. Power dissipation

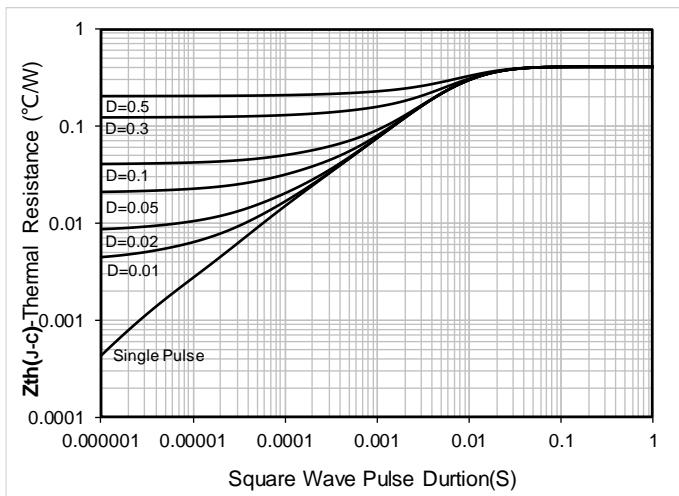


Figure 13. Maximum Transient Thermal Impedance

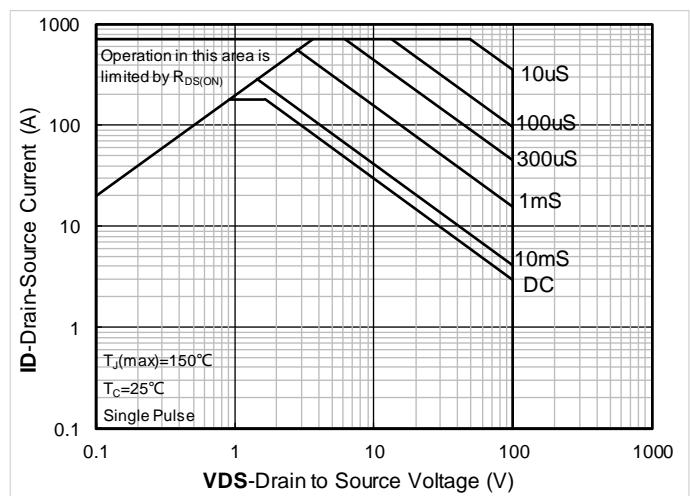


Figure 14. Safe Operation Area

■ Test Circuits & Waveforms

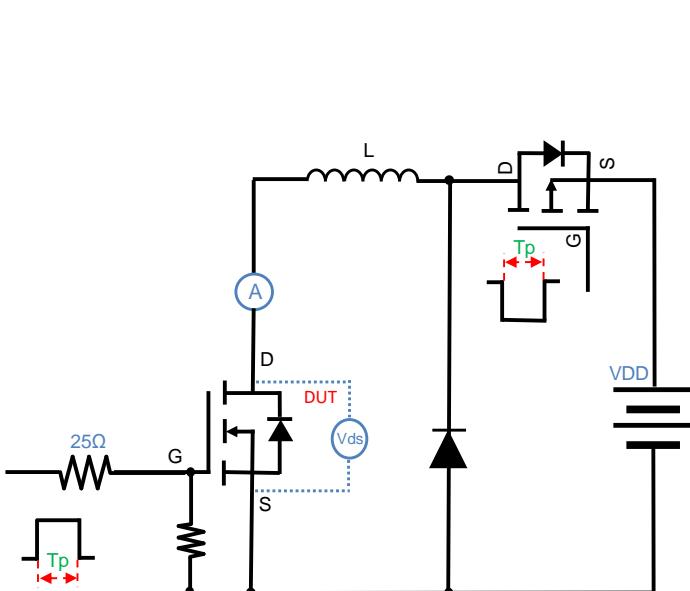
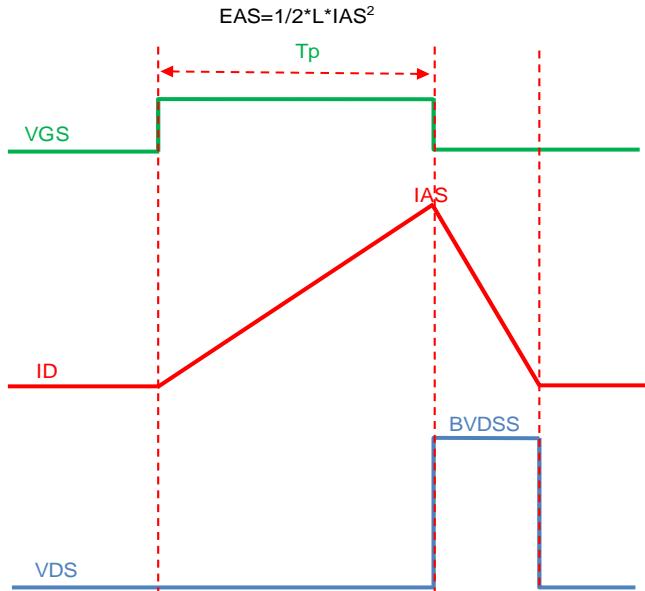


Figure A. Unclamped Inductive Switching (UIS) Test Circuit & Waveform



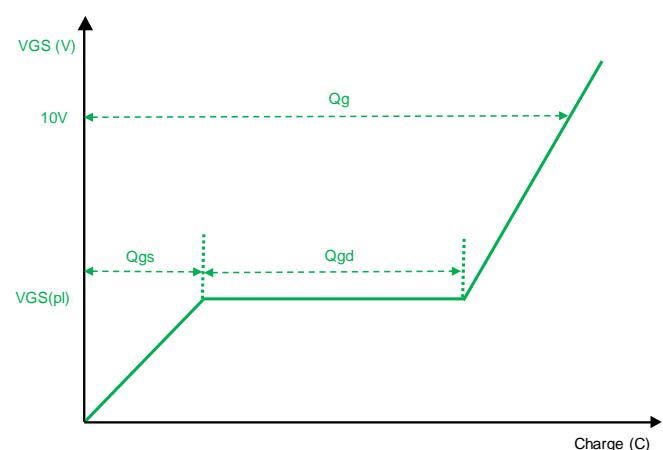
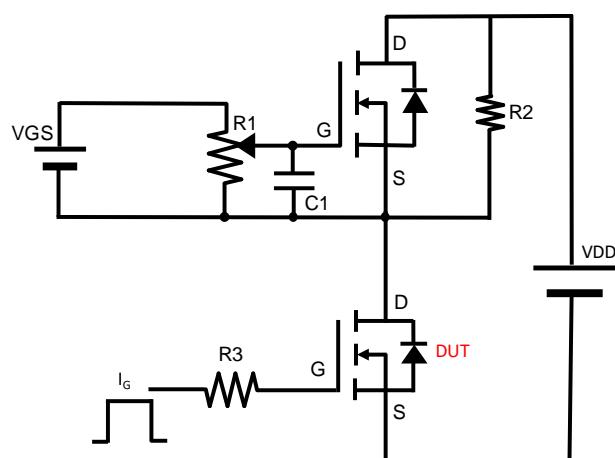


Figure B. Gate Charge Test Circuit & Waveform

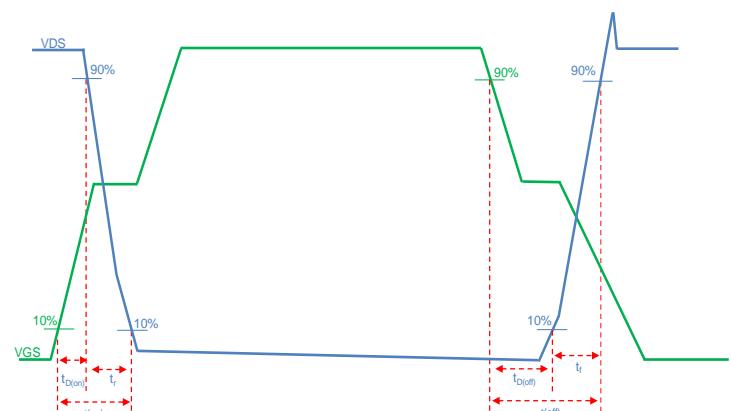
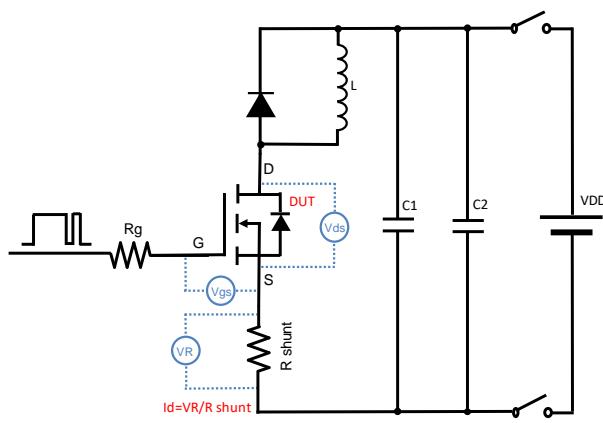


Figure C. Resistive Switching Test Circuit & Waveform

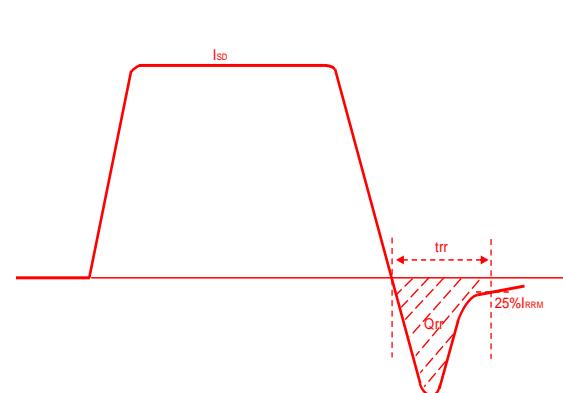
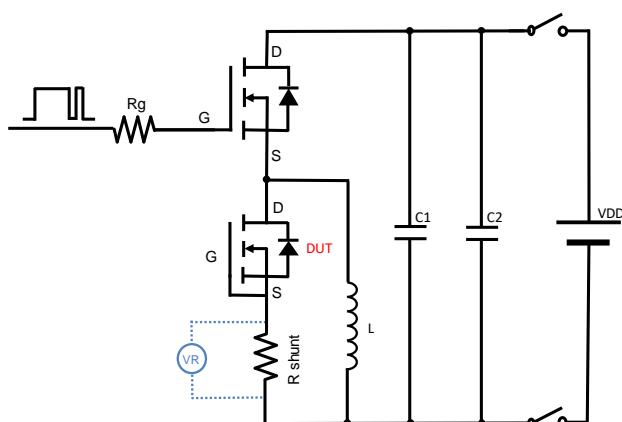
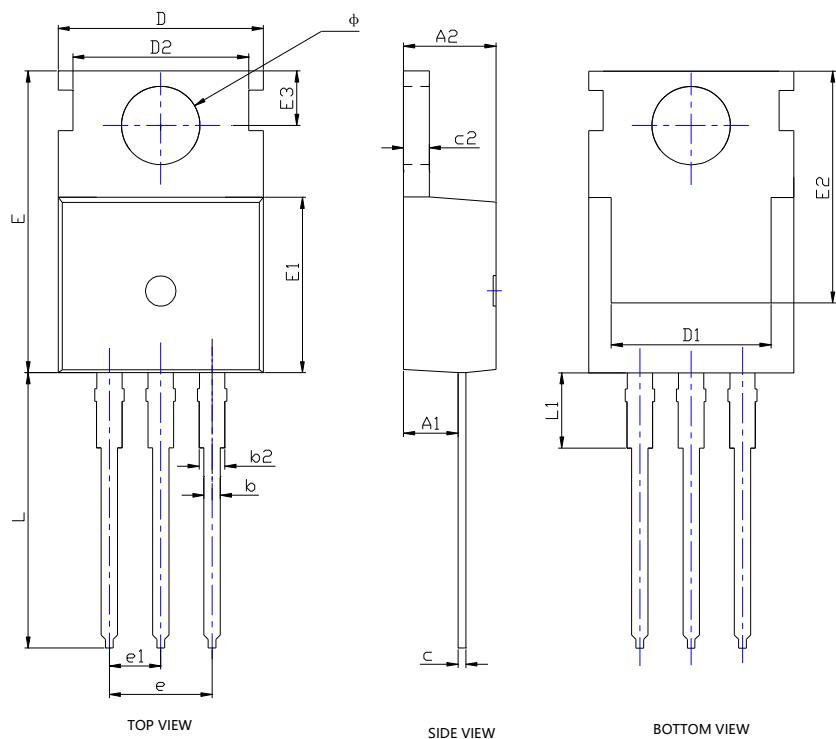


Figure D. Diode Recovery Test Circuit & Waveform

■ TO-220AB-C Package information



SYMBOL	DIMENSIONS		Millimeter	
	INCHES		MIN.	MAX.
A1	0.091	0.098	2.300	2.500
A2	0.173	0.181	4.400	4.600
b	0.028	0.035	0.700	0.900
b2	0.049	0.056	1.250	1.420
c	0.018	0.022	0.450	0.550
c2	0.049	0.053	1.250	1.350
D	0.382	0.402	9.700	10.200
D1	0.295	0.331	7.500	8.400
D2	0.335	0.350	8.500	8.900
E	0.602	0.634	15.300	16.100
E1	0.358	0.366	9.100	9.300
E2	0.497	0.525	12.630	13.330
E3	0.108BSC		2.750BSC	
e	0.200BSC		5.080BSC	
e1	0.100BSC		2.540BSC	
L	0.512	0.531	13.000	13.500
L1	---	0.138	---	3.500
Ø	0.140	0.148	3.550	3.750

NOTE:
 1.PACKAGE BODY SIZES EXCLUDE MOLD FLASH AND GATE BURRS.
 2.TOLERANCE 0.1mm UNLESS OTHERWISE SPECIFIED.

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